

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

AP
800

Applicant: Xiao-Chun Mu et al.

Title: Microelectronic Package Having an Integrated Heat Sink and Build-Up Layers

Docket No.: 884.798US1

Filed: December 8, 2000

Examiner: DiLinh Nguyen

Customer No.: 21186



Serial No.: 09/733289

Due Date: October 22, 2003

Group Art Unit: 2814

Confirmation No.: 2980

MS AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

RECEIVED
OCT 28 2003
TECHNOLOGY CENTER 2800

We are transmitting herewith the following attached items (as indicated with an "X"):

☒ A return postcard.

☒ A Response Under 37 C.F.R. 1.116 (16 Pages).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: Ann M. McCrackin
Atty: Ann M. McCrackin
Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 24 day of October 2003.

Anne M. Richards
Name

Ann M. Richards
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

(GENERAL)



EXPEDITED PROCEDURE –EXAMINING GROUP 2814

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Xiao-Chun Mu et al. Examiner: DiLinh Nguyen
Serial No.: 09/733289 Group Art Unit: 2814
Filed: December 8, 2000 Docket No.: 884.798US1
Title: Microelectronic Package Having an Integrated Heat Sink and Build-Up Layers
Assignee: Intel Corporation Customer No.: 2118

RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RECEIVED
OCT 28 2003
TECHNOLOGY CENTER 2800

In response to the final Office Action mailed July 22, 2003, please consider the following remarks: